ASSOCIATION CONNECTING ELECTRONICS INDUSTRIES OF COpyright 2 international a	Composition De 2005. IPC, Bannockt nd Pan-American co	claration ourn, Illinois. A opyright conve	All rights reserved untions.	under both	This docume level parts, th	ent is a declarati he declaration e	on of the substa	nces within the m lower level mater	anufacturer li ials for which	isted item. Note: i the manufacture	f the item is an a r has engineering	ssembly with low responsibility.
	1 IPC Web Site for Information on IPC-1752 Standard Form Type			Form Type Distribute	*		Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Materials and Mfg Information					
upplier Information												
Company name* Company			ique ID	le ID Unic			Unique ID Authority			Response Date*		
nsemi									20	25-06-01		
Contact Name Title			ct]	Phone - Contact* Email - Contact*						
Product-Env-Stewards	Product Enviro Compliance				NA			P	Product-Env-Stewards@onsemi.com			
Authorized Representative* Tit		Title - Repre	sentative	tative Pt			10ne - Representative*			Email - Representative*		
Product-Env-Stewards Pro-			ro Compliance		NA Product-Env-Stewards@onsemi.com				om			
Requester Item Number Mfr Item		Number	Number Mfr Item Name			Effective Date	Version	Manufacturin	Manufacturing Site		UOM	Unit Type
	NVXR1	NVXR17S90M2SPC SiC 900V 8		MOSFET V-SSDC SPC		2025-06-01		CNG		702203.25	mg	Each
Ianufacturing Proccess Info	ormation		1									
Terminal Plating / Grid Array Material Terminal Base		erminal Base	Alloy	J-STD-020 MSI	20 MSL Rating Peak Proc		Process Body Temperature Max Time at Peak		e at Peak Ter	nperature Numl	per of Reflow Cy	cles
Matte Tin (Sn) - annealed	1 0	CU Alloy		NA		0	C	30		seconds 3		
omments												
or more information regarding ma	terial composition	please refer to	page 3									

RoHS Material Composition Declaration				Declaration Type *	Detailed					
Directive 2015/863/EU amending RoHS Directive 2011/65/EU		nium (Cr6+), Polybro	ominated Biphenyls (PBB), Polybron	dmium and quantity limit of 0.1% by mass (100 minated Diphenyl Ethers (PBDE), and Bis(2-eth						
cadmium, hexavalentchromium, polybrominate contains a RoHS restricted substance inexcess encompass all such components. Supplier certif as of the date that Supplier completes this form Company acknowledges that Supplier may hav independently verified information provided by certification in this paragraph. If the Company a	ed biphenyls and/or polybrominated dip of an applicable quantity limit, please ir ies that it gathered the information it pro- .Supplier acknowledges that Company e relied on informationprovided by othe v others, Supplier agrees that, at a minin and the Supplier enter into a written agre pource of the Supplier's liability and the	henyl ethers (each a " ndicate below which, i ovides in this form us will rely on this certifiers in completing this num, itssuppliers have eement with respect to Company's remedies	RoHS restricted substance") in exce if any, RoHS exemption you believe ing appropriate methods to ensure if ication in determining the complian form, and that Supplier may not have e provided certifications regarding the to the identified part, the terms and co for issues that arise regarding inform	ce of its products with European Union membe	ove. If a homogeneous material within the part er level components, the declaration shall l correct to the best of its knowledge and belief, r state laws that implement the RoHS Directive. wever, in situations where Supplier has not tions are at least as comprehensive as the anty rights and/or remedies provided as part of					
RoHS Declaration * 1 - Item(s)	does not contain RoHS restricted substa	ances per the definitio	on above	Supplier Acceptance	* Accepted					
Exemption: If the declared item does not contain RoHS restricted substances per the definition above except for defined RoHS exemptions, then select the corresponding response in the RoHS Declaration above and choose all applicable exemptions.										
Exemption List Version	EL-2011/534/EU									
Declaration Signature										
Instructions: Complete all of the required fin Requester) and click on Submit Form to have	elds on all pages of this form. Select the form returned to the Requester	he "Accepted" on th	e Supplier Acceptance drop-down	. This will display the signature area. Digital	lly sign the declaration (if required by the					
Supplier Digital Signature Ra	stislav Drska	Le								

Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Case	83300.0	mg	Supplier	Fiber Glass (SiO2)	65997-17-3		24990.002	mg
			Supplier	Poly(ButyleneTerephthalate)	30965-26-5		23324	mg
			В	Antimony Trioxide (Sb2O3)	1309-64-4		2915.5	mg
			Supplier	PBT	26062-94-2		23324	mg
			-	Carbonic Dichloride	94334-64-2		8746.5	mg
Cover	27000.0	mg	Supplier	Fiber Glass (SiO2)	65997-17-3		8100.0005	mg
			Supplier	Poly(ButyleneTerephthalate)	30965-26-5		7560	mg
			В	Antimony Trioxide (Sb2O3)	1309-64-4		945	mg
			Supplier	PBT	26062-94-2		7560	mg
			-	Carbonic Dichloride	94334-64-2		2835	mg
DBC	47100.0	mg	Supplier	Yitrium Oxide	1314-36-9		155.43	mg
			Supplier	Silicon Nitride SiN	12033-60-2		7536	mg
			Supplier	Indium (In)	7440-74-6		37.68	mg
			Supplier	Titanium (Ti)	7440-32-6		75.36	mg
			Supplier	Silver (Ag)	7440-22-4		1092.72	mg
			Supplier	Magnesium Monoxide (MgO)	1309-48-4		235.5	mg
			Supplier	Misc.	Proprietary Data		14.13	mg
			Supplier	Copper (Cu)	7440-50-8		37953.1797	mg
Die	1.95	mg	Supplier	Silicon (Si)	7440-21-3		1.95	mg
Die Attach Solder	3000.0	mg	Supplier	Silver (Ag)	7440-22-4		120	mg
			Supplier	Tin (Sn)	7440-31-5		2865	mg
			Supplier	Misc.	Proprietary Data		15	mg
Glue	600.0	mg	Supplier	2,3-epoxypropyl-trimethoxysilan	2530-83-8		60	mg
			Supplier	Miscellaneous	Trade Secret		60	mg
			Supplier	Silica Crystalline (SiO2)	14808-60-7		480	mg
Plating	80.0	mg	Supplier	Tin (Sn)	7440-31-5		40	mg
			В	Nickel (Ni)	7440-02-0		40	mg
Screw	3000.0	mg	Supplier	Sulfur (S)	7704-34-9		1.2	mg
			Supplier	Carbon (C)	7440-44-0		15	mg
			Supplier	Manganese (Mn)	7439-96-5		27	mg
			Supplier	Silicon (Si)	7440-21-3		15	mg
			Supplier	Iron (Fe)	7439-89-6		2940.6001	mg

			Supplier	Phosphorus (P)	7723-14-0	1.2	mg
Silicone Gel	32000.0	mg	Supplier	Silicone	70900-21-9	3040	mg
			Supplier	Hexamethyldisilazane	68909-20-6	160	mg
			Supplier	Dimethyl Siloxane	68083-19-2	28800	mg
Solder preform	17000.0	mg	Supplier	Silver (Ag)	7440-22-4	544	mg
			Supplier	Tin (Sn)	7440-31-5	15401.999	mg
			В	Antimony (Sb)	7440-36-0	935	mg
			Supplier	Copper (Cu)	7440-50-8	119	mg
Terminal	3000.0	mg	Supplier	Silicon (Si)	7440-21-3	8.1	mg
			В	Nickel (Ni)	7440-02-0	40.5	mg
			Supplier	Copper (Cu)	7440-50-8	2950.6501	mg
			Supplier	Phosphorus (P)	7723-14-0	0.7498	mg
Terminal Holder	486000.0	mg	Supplier	Silver (Ag)	7440-22-4	145.8	mg
			Supplier	Copper (Cu)	7440-50-8	485854.1875	mg
Thermistor	120.0	mg	Supplier	Tin (Sn)	7440-31-5	1.5	mg
			Supplier	Nickel Oxide (NiO)	1313-99-1	0.18	mg
			В	Antimony Trioxide (Sb2O3)	1309-64-4	0.192	mg
			В	Nickel (Ni)	7440-02-0	28.02	mg
			Supplier	Gold (Au)	7440-57-5	0.024	mg
			Supplier	Iron (Fe)	7439-89-6	30	mg
			А	Lead Oxide (PbO)	1317-36-8	27.504	mg
			Supplier	Cobalt Oxide (Co3O4)	1308-06-1	0.18	mg
			Supplier	Manganese Tetraoxide (Mn3O4)	1317-35-7	0.18	mg
			Supplier	Potassium Monoxide (K2O)	12136-45-7	2.328	mg
			Supplier	Copper (Cu)	7440-50-8	13.26	mg
			Supplier	Silica Crystalline (SiO2)	14808-60-7	16.632	mg
Wire Bond - Al	1.315	mg	Supplier	Aluminum (Al)	7429-90-5	1.315	mg